
**Is Now Part of**


**ON Semiconductor®**

**To learn more about ON Semiconductor, please visit our website at**
**www.onsemi.com**

FAIRCHILD SEMICONDUCTOR®

February 2002

# IRFP460C

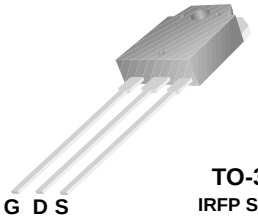
## 500V N-Channel MOSFET

## General Description

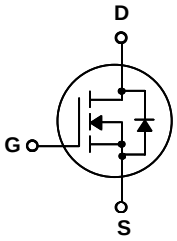
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies and power factor corrections.

## Features

- 20A, 500V, $R_{DS(on)}$ = 0.24Ω @$V_{GS}$ = 10 V
- Low gate charge ( typical 130nC)
- Low Crss ( typical 60 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability




**TO-3PN**
**IRFP Series**




## Absolute Maximum Ratings

$T_C$ = 25°C unless otherwise noted

| Symbol | Parameter | | IRFP460C | Units |
|---|---|---|---|---|
| $V_{DSS}$ | Drain-Source Voltage | | 500 | V |
| $I_D$ | Drain Current - Continuous ($T_C$ = 25°C) | | 20 | A |
| | Drain Current - Continuous ($T_C$ = 100°C) | | 12.5 | A |
| $I_{DM}$ | Drain Current - Pulsed | (Note 1) | 80 | A |
| $V_{GSS}$ | Gate-Source Voltage | | ± 30 | V |
| $E_{AS}$ | Single Pulsed Avalanche Energy | (Note 2) | 1050 | mJ |
| $I_{AR}$ | Avalanche Current | (Note 1) | 20 | A |
| $E_{AR}$ | Repetitive Avalanche Energy | (Note 1) | 23.5 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 4.5 | V/ns |
| $P_D$ | Power Dissipation ($T_C$ = 25°C) | | 235 | W |
| | - Derate above 25°C | | 1.88 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | -55 to +150 | °C |
| $T_L$ | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | | 300 | °C |

## Thermal Characteristics

| Symbol | Parameter | Typ | Max | Units |
|---|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | -- | 0.53 | °C/W |
| $R_{\theta CS}$ | Thermal Resistance, Case-to-Sink | 0.24 | -- | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | -- | 40 | °C/W |

## Electrical Characteristics

$T_C$ = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| **Off Characteristics** | | | | | | |
| $BV_{DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}$ = 0 V, $I_D$ = 250 μA | 500 | -- | -- | V |
| $\Delta BV_{DSS}$ / $\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 250 μA, Referenced to 25°C | -- | 0.55 | -- | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 500 V, $V_{GS}$ = 0 V | -- | -- | 10 | μA |
| | | $V_{DS}$ = 400 V, $T_C$ = 125°C | -- | -- | 100 | μA |
| $I_{GSSF}$ | Gate-Body Leakage Current, Forward | $V_{GS}$ = 30 V, $V_{DS}$ = 0 V | -- | -- | 100 | nA |
| $I_{GSSR}$ | Gate-Body Leakage Current, Reverse | $V_{GS}$ = -30 V, $V_{DS}$ = 0 V | -- | -- | -100 | nA |
| **On Characteristics** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 μA | 2.0 | -- | 4.0 | V |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance | $V_{GS}$ = 10 V, $I_D$ = 10.0 A | -- | 0.2 | 0.24 | Ω |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 50 V, $I_D$ = 10.0 A (Note 4) | -- | 18 | -- | S |
| **Dynamic Characteristics** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1.0 MHz | -- | 4590 | 6000 | pF |
| $C_{oss}$ | Output Capacitance | | -- | 380 | 460 | pF |
| $C_{rss}$ | Reverse Transfer Capacitance | | -- | 60 | 80 | pF |
| **Switching Characteristics** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 250 V, $I_D$ = 20 A, $R_G$ = 25 Ω (Note 4, 5) | -- | 50 | 120 | ns |
| $t_r$ | Turn-On Rise Time | | -- | 150 | 310 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 380 | 770 | ns |
| $t_f$ | Turn-Off Fall Time | | -- | 180 | 370 | ns |
| $Q_g$ | Total Gate Charge | $V_{DS}$ = 400 V, $I_D$ = 20 A, $V_{GS}$ = 10 V (Note 4, 5) | -- | 130 | 170 | nC |
| $Q_{gs}$ | Gate-Source Charge | | -- | 20 | -- | nC |
| $Q_{gd}$ | Gate-Drain Charge | | -- | 45 | -- | nC |
| **Drain-Source Diode Characteristics and Maximum Ratings** | | | | | | |
| $I_S$ | Maximum Continuous Drain-Source Diode Forward Current | | -- | -- | 20 | A |
| $I_{SM}$ | Maximum Pulsed Drain-Source Diode Forward Current | | -- | -- | 80 | A |
| $V_{SD}$ | Drain-Source Diode Forward Voltage | $V_{GS}$ = 0 V, $I_S$ = 20 A | -- | -- | 1.4 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{GS}$ = 0 V, $I_S$ = 20 A, $dI_F$ / dt = 100 A/μs (Note 4) | -- | 480 | -- | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | -- | 7.7 | -- | μC |

**Notes:**
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 5.1mH, $I_{AS}$ = 20A, $V_{DD}$ = 50V, $R_G$ = 25 Ω, Starting $T_J$ = 25°C
3. $I_{SD}$ ≤ 20A, di/dt ≤ 200A/μs, $V_{DD}$ ≤ $BV_{DSS}$, Starting $T_J$ = 25°C
4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
5. Essentially independent of operating temperature

## Typical Characteristics

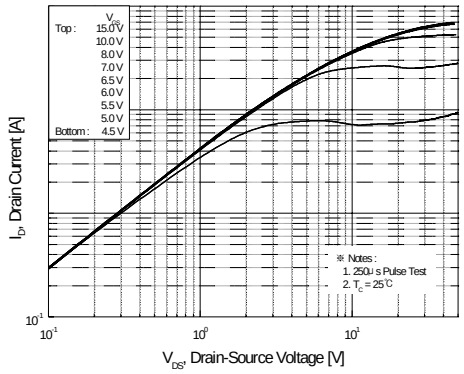



**Figure 1. On-Region Characteristics**

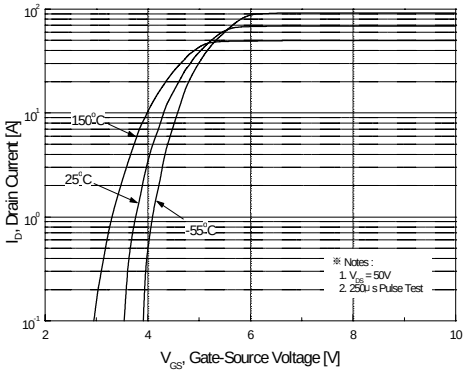



**Figure 2. Transfer Characteristics**

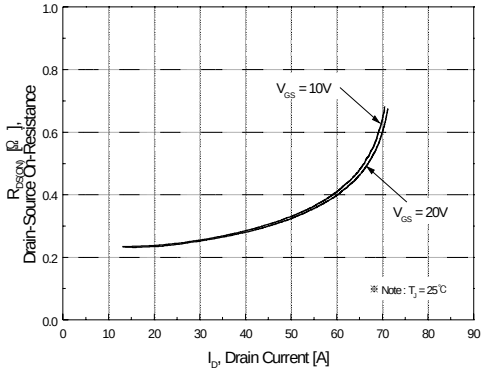



**Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage**

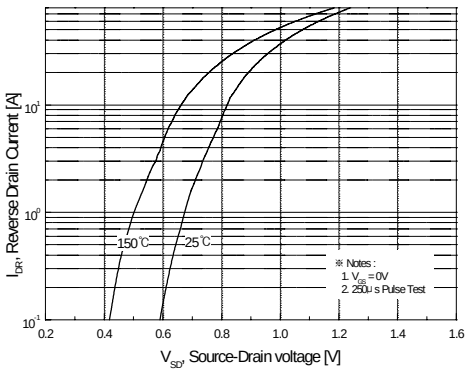



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

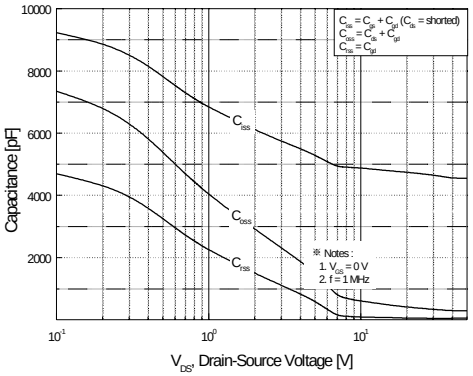



**Figure 5. Capacitance Characteristics**

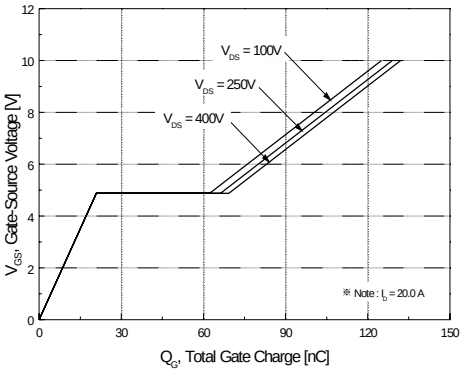



**Figure 6. Gate Charge Characteristics**

Dimensions in Millimeters

## Typical Characteristics (Continued)

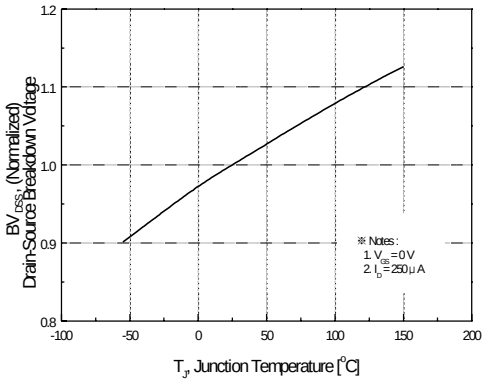



**Figure 7. Breakdown Voltage Variation vs Temperature**

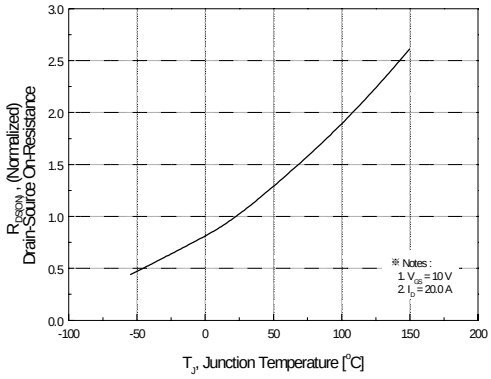



**Figure 8. On-Resistance Variation vs Temperature**

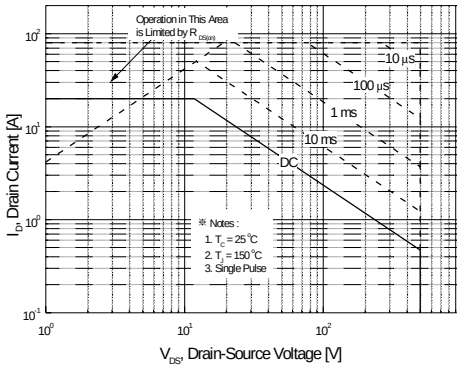



**Figure 9. Maximum Safe Operating Area**

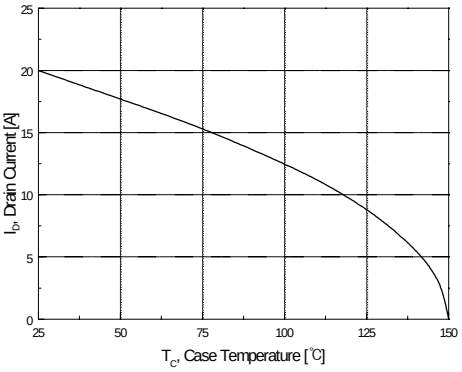



**Figure 10. Maximum Drain Current vs Case Temperature**

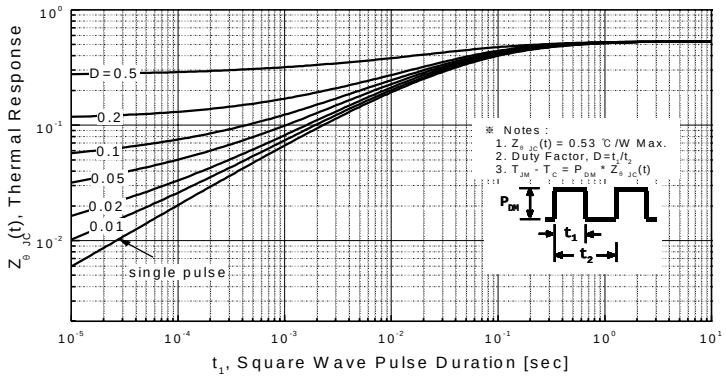
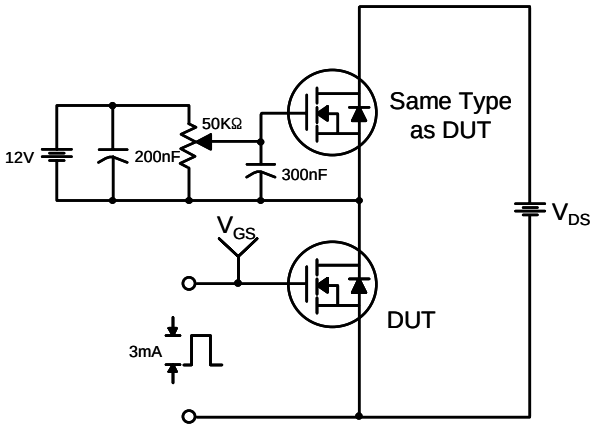
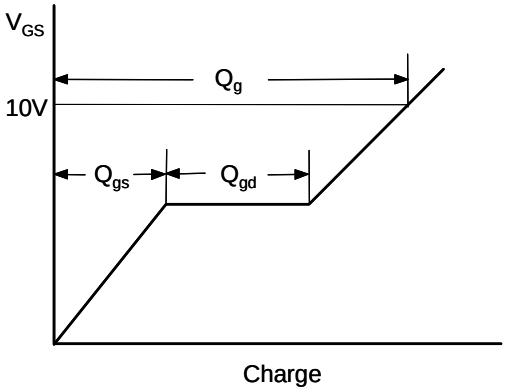



**Figure 11. Transient Thermal Response Curve**

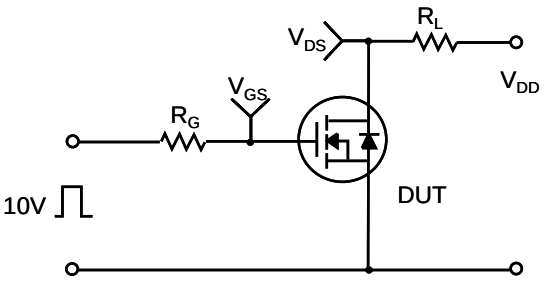
Dimensions in Millimeters

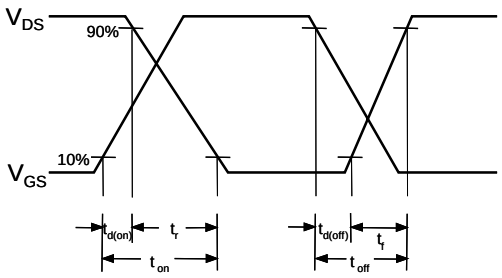
### Gate Charge Test Circuit & Waveform



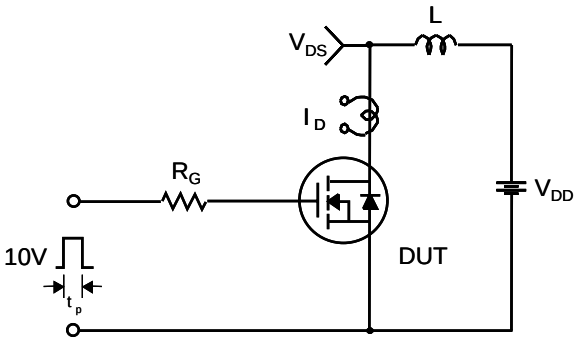




### Resistive Switching Test Circuit & Waveforms

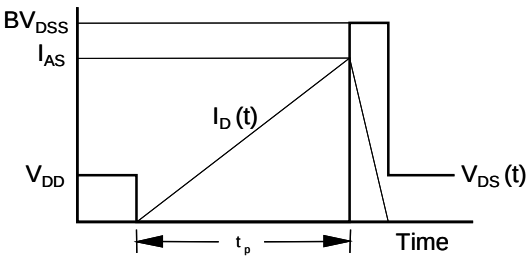



### Unclamped Inductive Switching Test Circuit & Waveforms

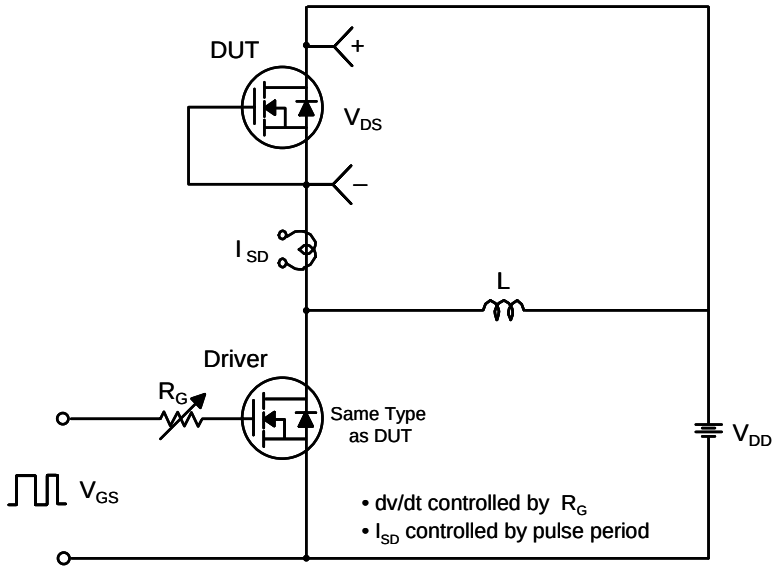


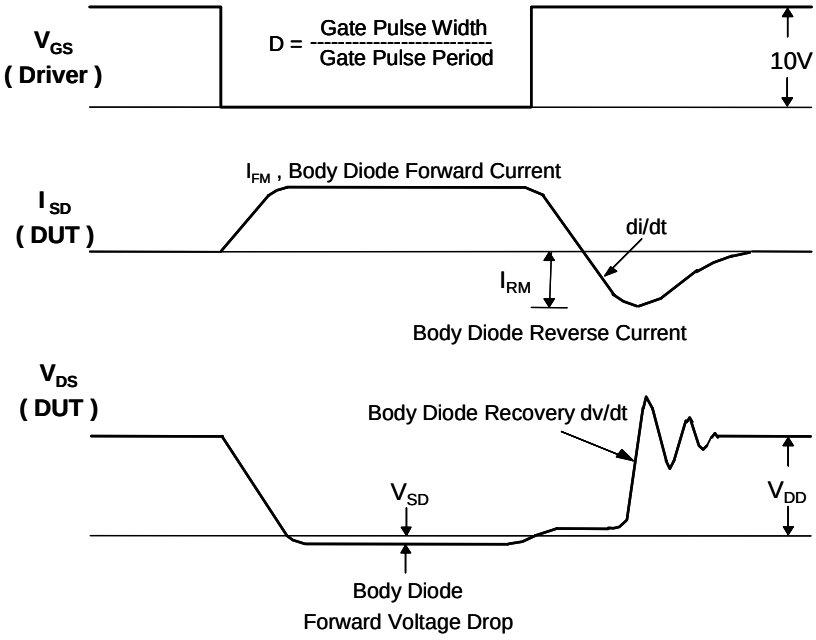

$$E_{AS} = \frac{1}{2} L I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$




Dimensions in Millimeters

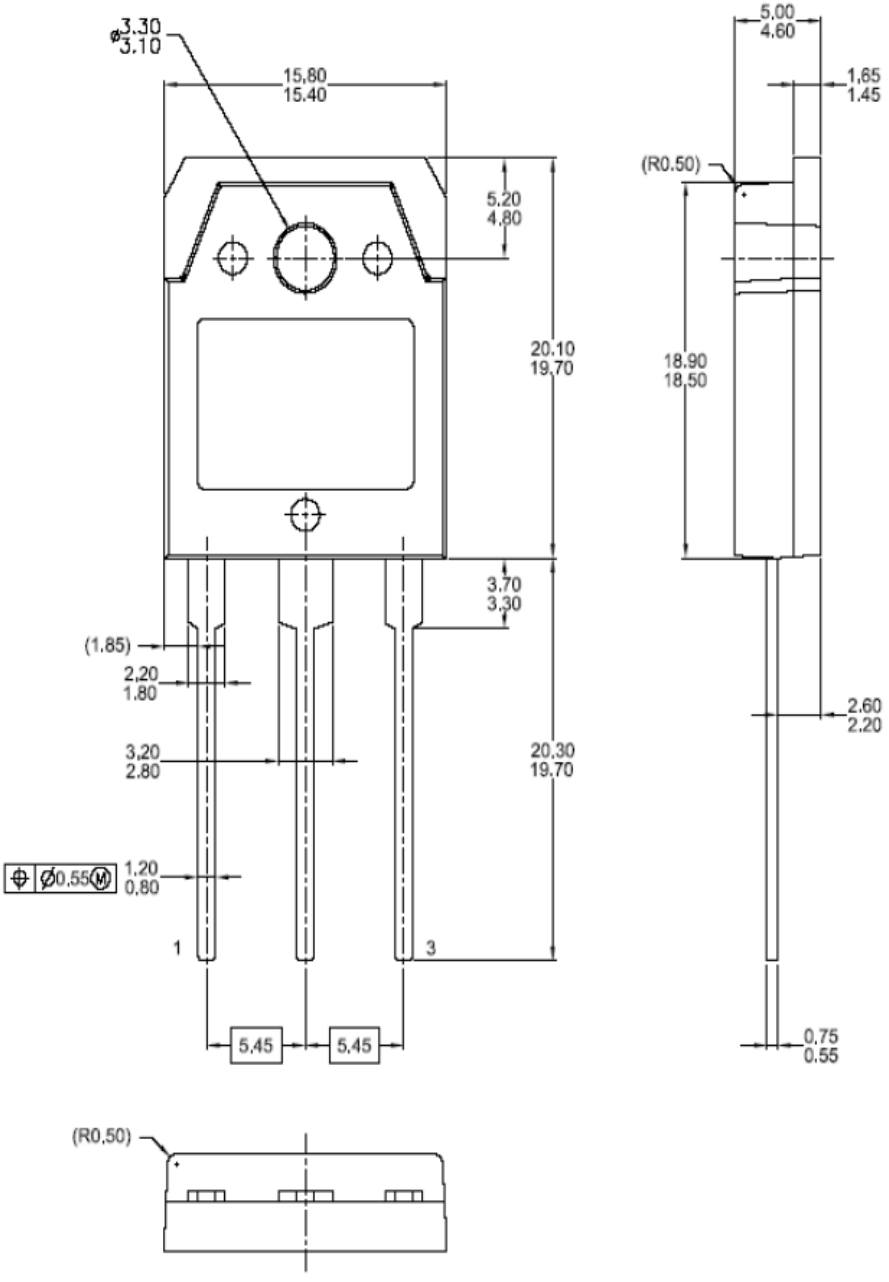
**Peak Diode Recovery dv/dt Test Circuit & Waveforms**



## Mechanical Dimensions

### TO-3PN




Dimensions in Millimeters

## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| | | | | |
|---|---|---|---|---|
| ACEx™ | FAST® | OPTOLOGIC™ | SMART START™ | VCX™ |
| Bottomless™ | FASTr™ | OPTOPLANAR™ | STAR*POWER™ | |
| CoolFET™ | FRFET™ | PACMAN™ | Stealth™ | |
| *CROSSVOLT*™ | GlobalOptoisolator™ | POP™ | SuperSOT™-3 | |
| DenseTrench™ | GTO™ | Power247™ | SuperSOT™-6 | |
| DOME™ | HiSeC™ | PowerTrench® | SuperSOT™-8 | |
| EcoSPARK™ | ISOPLANAR™ | QFET™ | SyncFET™ | |
| $E^2$CMOS™ | LittleFET™ | QS™ | TruTranslation™ | |
| EnSigna™ | MicroFET™ | QT Optoelectronics™ | TinyLogic™ | |
| FACT™ | MicroPak™ | Quiet Series™ | UHC™ | |
| FACT Quiet Series™ | MICROWIRE™ | SLIENT SWITCHER® | UltraFET® | |

STAR*POWER is used under license

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

| Datasheet Identification | Product Status | Definition |
|---|---|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |

## PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT**:
Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
**Phone**: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
**Fax**: 303−675−2176 or 800−344−3867 Toll Free USA/Canada
**Email**: orderlit@onsemi.com

**N. American Technical Support**: 800−282−9855 Toll Free USA/Canada
**Europe, Middle East and Africa Technical Support:**
Phone: 421 33 790 2910
**Japan Customer Focus Center**
Phone: 81−3−5817−1050

**ON Semiconductor Website**: **www.onsemi.com**

**Order Literature**: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

IRFP460C